

## 5 V, SUPER MINIMOLD WIDEBAND SI RFIC AMPLIFIER

### FEATURES

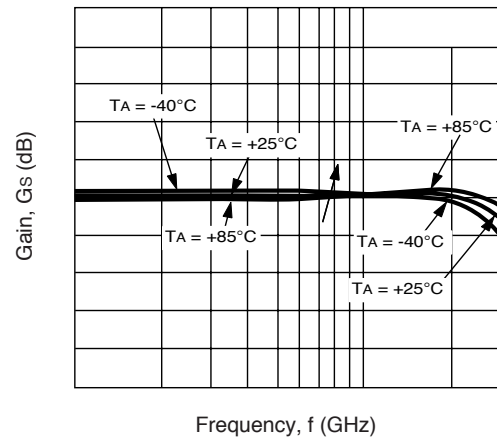
- **HIGH DENSITY SURFACE MOUNTING:**  
6 pin super minimold or SOT-363 package
- **HIGH GAIN:** 15 dB TYP
- **SATURATED OUTPUT POWER:** +10 dBm
- **WIDEBAND RESPONSE:**  $f_u = 2.9$  GHz TYP
- **SUPPLY VOLTAGE:**  $V_{CC} = 4.5$  to  $5.5$  V

### DESCRIPTION

The UPC2708TB is a Silicon RFIC manufactured using the NESAT III process. This device is suitable as buffer amplifier for DBS, PCS and other communication receivers. The UPC2708TB is pin compatible and has comparable performance as the larger UPC2708T, so it is suitable for use as a replacement to help reduce system size. The IC is housed in a 6 pin super minimold or SOT-363 package.

Stringent quality assurance and test procedures ensure the highest reliability and performance.

GAIN vs.  
FREQUENCY and TEMPERATURE



### ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ , $f = 1$ GHz, $V_{CC} = 5$ V)

PART NUMBER PACKAGE OUTLINE			UPC2708TB S06		
SYMBOLS	PARAMETERS AND CONDITIONS	UNITS	MIN	TYP	MAX
$I_{CC}$	Circuit Current (no signal)	mA	20	26	33
$G_s$	Small Signal Gain	dB	13	15	18.5
$f_u$	Upper Limit Operating Frequency (The gain at $f_u$ is 3 dB down from the gain at 0.1 GHz)	GHz	2.7	2.9	
$\Delta G_s$	Gain Flatness, $f = 0.1 - 2.6$ GHz	dB		$\pm 0.8$	
$P_{SAT}$	Saturated Output Power	dBm	+7.5	+10	
$P_{1dB}$	Output Power at 1 dB Compression Point	dBm		+7.5	
NF	Noise Figure	dB		6.5	8
$RL_{IN}$	Input Return Loss	dB	8	11	
$RL_{OUT}$	Output Return Loss	dB	16	20	
ISOL	Isolation	dB	18	23	
$\Delta G_T$	Gain-Temperature Coefficient	dB/ $^\circ\text{C}$		+0.002	
$R_{TH}$	Thermal Resistance (Junction to Ambient)	$^\circ\text{C}/\text{W}$			325

**ABSOLUTE MAXIMUM RATINGS<sup>1</sup>** (T<sub>A</sub> = 25°C)

SYMBOLS	PARAMETERS	UNITS	RATINGS
V <sub>CC</sub>	Supply Voltage	V	6
P <sub>IN</sub>	Input Power	dBm	+10
P <sub>T</sub>	Power Dissipation <sup>2</sup>	mW	200
T <sub>OP</sub>	Operating Temperature	°C	-40 to +85
T <sub>STG</sub>	Storage Temperature	°C	-55 to +150

Notes:

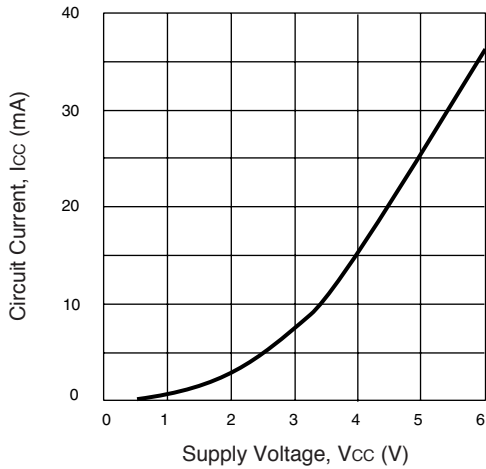
1. Operation in excess of any one of these parameters may result in permanent damage.
2. Mounted on 50 x 50 x 1.6 mm epoxy glass PWB (T<sub>A</sub> = +85°C).

**RECOMMENDED OPERATING CONDITIONS**

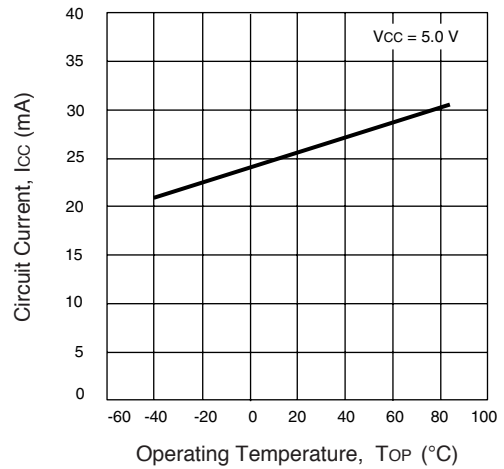
SYMBOL	PARAMETER	UNITS	MIN	TYP	MAX
V <sub>CC</sub>	Supply Voltage	V	4.5	5.0	5.5

**TYPICAL PERFORMANCE CURVES** (T<sub>A</sub> = 25°C)

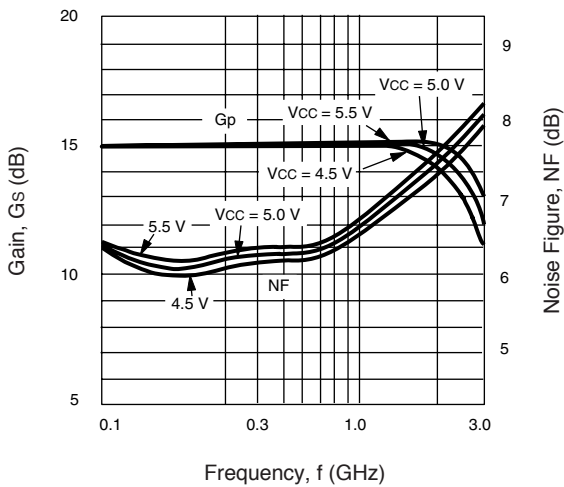
**CIRCUIT CURRENT vs. VOLTAGE**



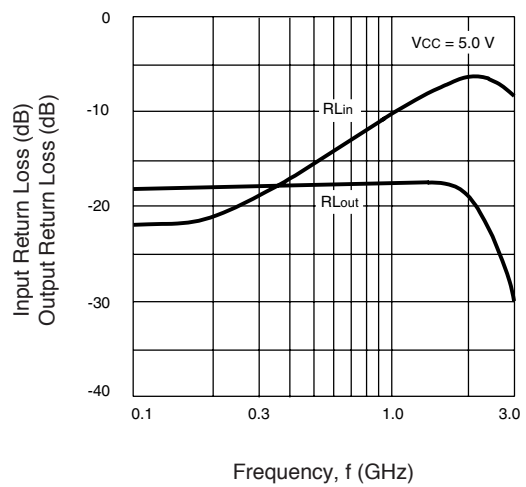
**CIRCUIT CURRENT vs. TEMPERATURE**



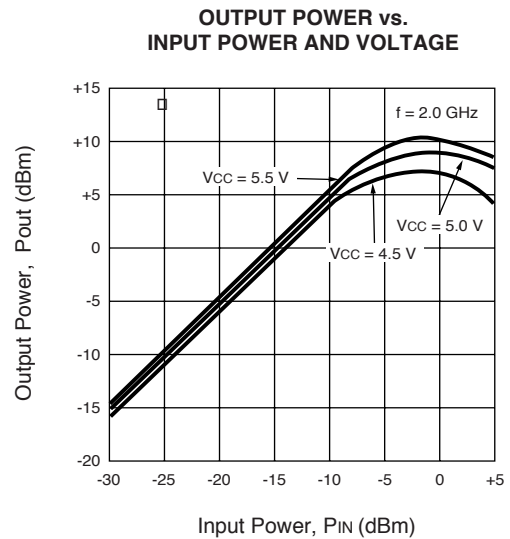
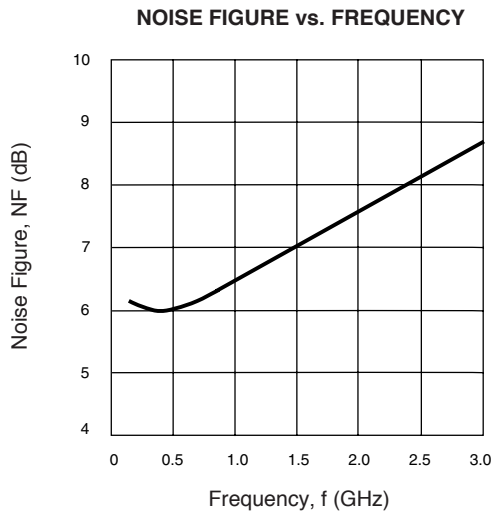
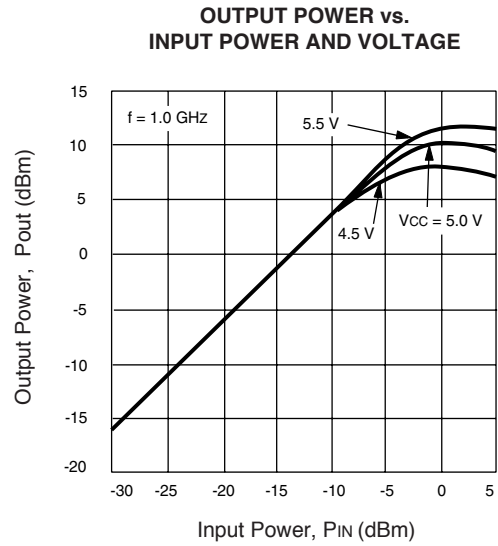
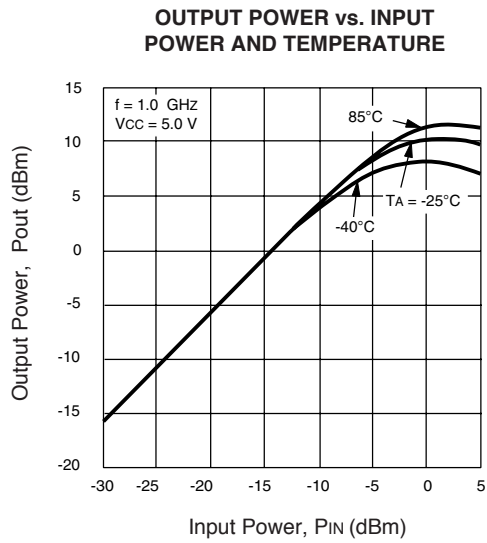
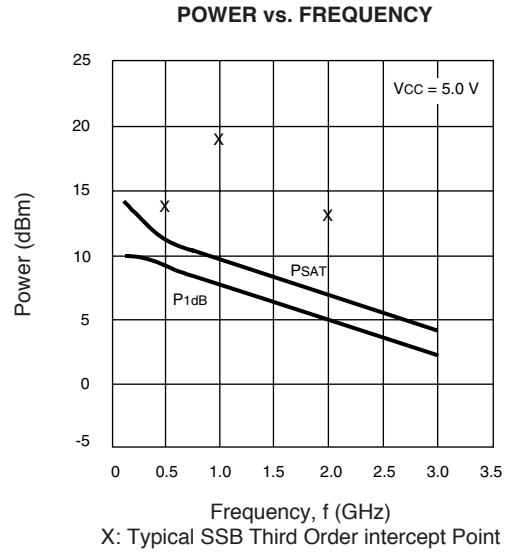
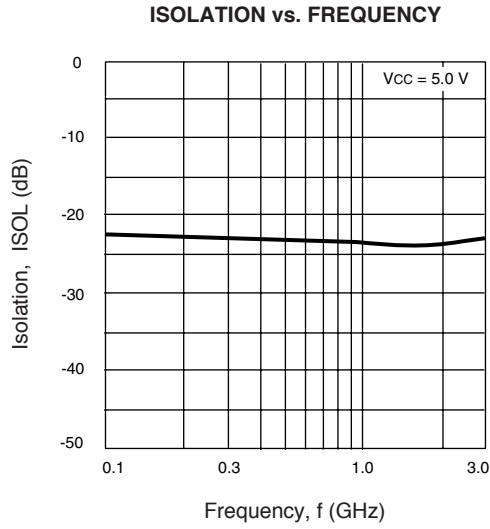
**GAIN AND NOISE FIGURE vs. FREQUENCY AND VOLTAGE**



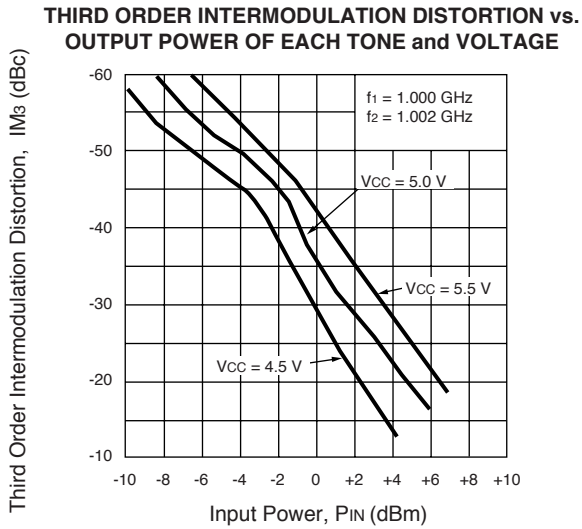
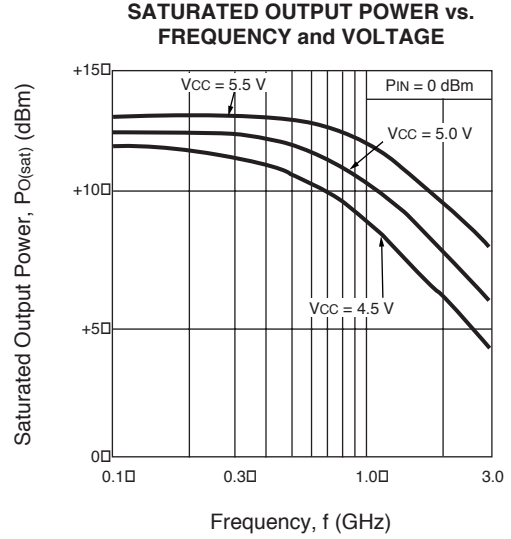
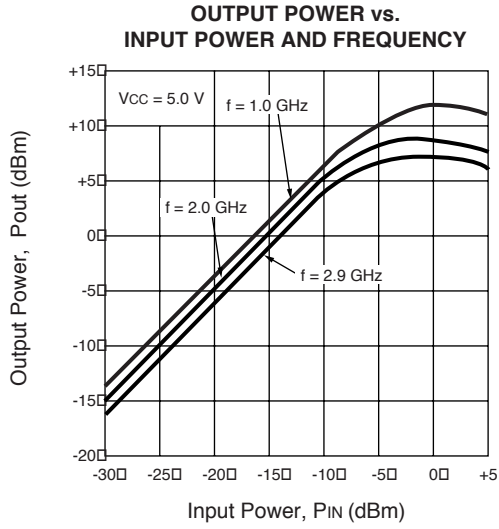
**INPUT RETURN LOSS, OUTPUT RETURN LOSS vs. FREQUENCY**



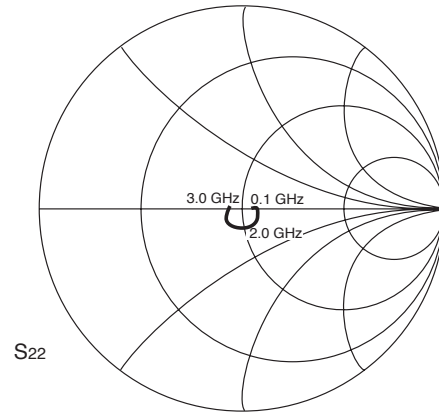
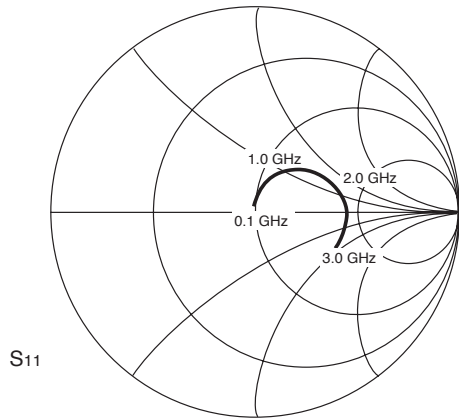
TYPICAL PERFORMANCE CURVES (TA = 25°C)



TYPICAL PERFORMANCE CURVES (T<sub>A</sub> = 25°C)



**TYPICAL SCATTERING PARAMETERS** ( $T_A = 25^\circ\text{C}$ ,  $V_{CC} = V_{OUT} = 5.0\text{ V}$ )



**UPC2708TB**

$V_{CC} = V_{OUT} = 5\text{ V}$ ,  $I_{CC} = 27\text{ mA}$

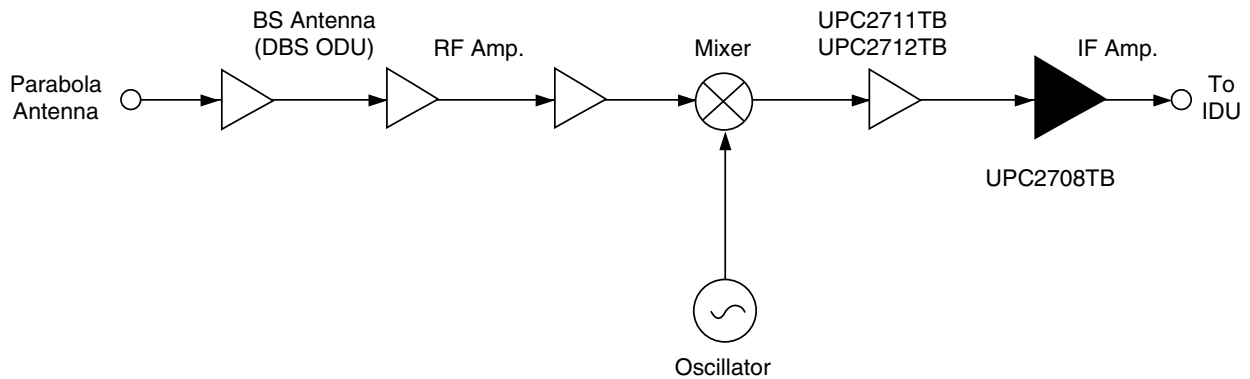
FREQUENCY GHz	S11		S21		S12		S22		K
	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG	
0.1	0.039	138.9	5.815	-4.8	0.077	-0.8	0.051	0.9	1.34
0.2	0.053	119.7	5.822	-9.8	0.075	-1.5	0.048	1.4	1.36
0.3	0.069	106.7	5.815	-14.3	0.074	-0.6	0.049	5.9	1.38
0.4	0.088	97.2	5.813	-18.8	0.074	-0.5	0.054	8.9	1.36
0.5	0.105	91.6	5.794	-23.8	0.072	-1.1	0.054	8.8	1.39
0.6	0.123	84.9	5.823	-28.4	0.071	-0.6	0.056	10.4	1.40
0.7	0.144	79.7	5.871	-33.0	0.070	0.1	0.060	11.5	1.40
0.8	0.164	74.7	5.890	-38.2	0.071	0.5	0.065	11.6	1.37
0.9	0.186	70.7	5.938	-42.8	0.073	2.3	0.072	11.1	1.34
1.0	0.205	66.1	5.960	-47.6	0.070	4.4	0.082	5.6	1.31
1.1	0.226	61.7	6.072	-52.7	0.069	5.0	0.091	-4.6	1.28
1.2	0.245	57.7	6.097	-57.5	0.070	4.4	0.082	5.6	1.31
1.3	0.263	53.7	6.174	-63.0	0.067	2.5	0.085	0.6	1.33
1.4	0.286	48.6	6.275	-68.4	0.069	5.0	0.091	-4.6	1.28
1.5	0.308	44.3	6.371	-74.3	0.070	5.4	0.092	-8.2	1.24
1.6	0.328	40.7	6.419	-79.8	0.066	7.1	0.097	-12.6	1.26
1.7	0.344	36.2	6.470	-85.9	0.067	5.6	0.096	-19.6	1.23
1.8	0.364	31.0	6.555	-92.1	0.069	8.2	0.100	-23.9	1.18
1.9	0.382	26.0	6.542	-98.3	0.070	8.4	0.092	-8.2	1.24
2.0	0.395	21.2	6.570	-104.7	0.070	8.7	0.101	-38.9	1.13
2.1	0.405	16.8	6.528	-111.3	0.070	10.1	0.100	-47.2	1.12
2.2	0.417	11.8	6.527	-118.5	0.071	9.4	0.096	-57.2	1.09
2.3	0.427	6.6	6.438	-124.7	0.072	9.5	0.098	-66.1	1.09
2.4	0.431	2.2	6.336	-131.3	0.071	10.7	0.095	-76.5	1.09
2.5	0.431	-3.0	6.247	-138.1	0.072	12.8	0.098	-86.1	1.09
2.6	0.434	-8.2	6.127	-145.0	0.071	15.4	0.094	-99.9	1.10
2.7	0.423	-12.3	5.952	-151.7	0.071	14.5	0.088	-116.7	1.14
2.8	0.419	-17.1	5.816	-158.2	0.070	16.1	0.081	-134.4	1.18
2.9	0.408	-21.5	5.619	-165.0	0.073	15.3	0.074	-149.7	1.19
3.0	0.400	-26.2	5.354	-171.5	0.074	17.1	0.065	-170.3	1.24
3.1	0.386	-29.3	5.134	-177.4	0.075	17.1	0.053	172.8	1.28

**PIN DESCRIPTIONS**

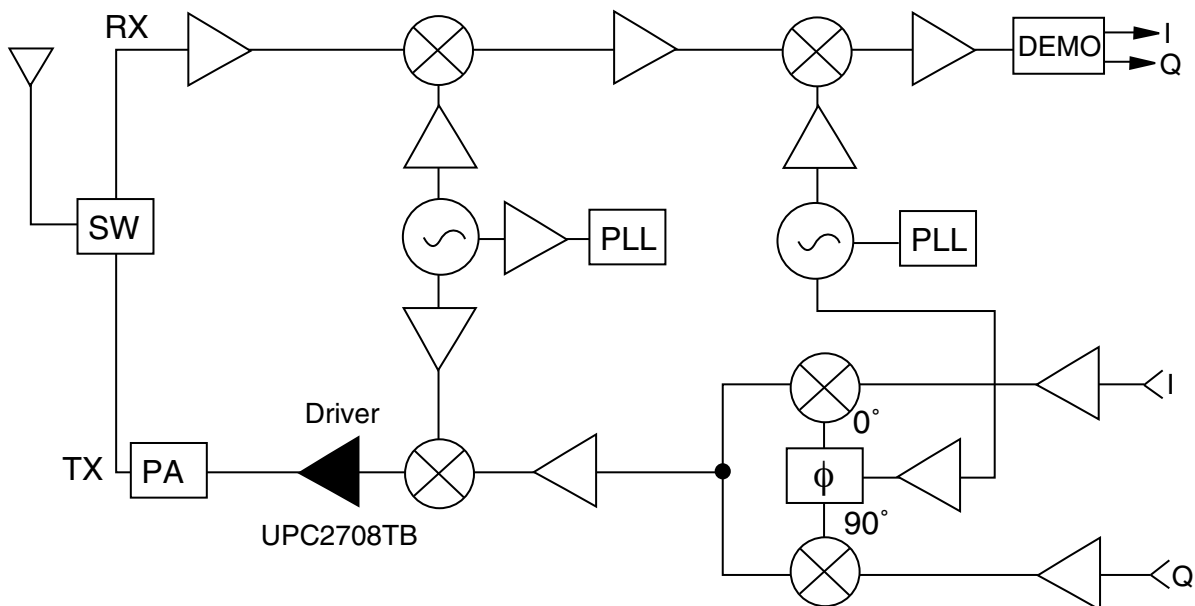
Pin No.	Symbol	Applied Voltage (V)	Pin Voltage (V)	Description	Internal Equivalent Circuit
1	Input	–	1.16	Signal input pin. An internal matching circuit, configured with resistors, enables 50 Ω connection over a wide bandwidth. A multi-feedback circuit is designed to cancel the deviations of hFE and resistance. This pin must be coupled to the signal source with a blocking capacitor.	
4	Output	–	–	Signal output pin. Connect an inductor between this pin and Vcc to supply current to the internal output transistors.	
6	Vcc	4.5 to 5.5	–	Power supply pin. This pin should be externally equipped with a bypass capacitor to minimize ground impedance.	
2 3 5	GND	0	–	Ground pins. These pins should be connected to system ground with minimum inductance. Ground pattern on the board should be formed as wide as possible. All the ground pins must be connected together with wide ground pattern to minimize impedance difference.	

**SYSTEM APPLICATION EXAMPLE**

**EXAMPLE OF DBS CONVERTERS**

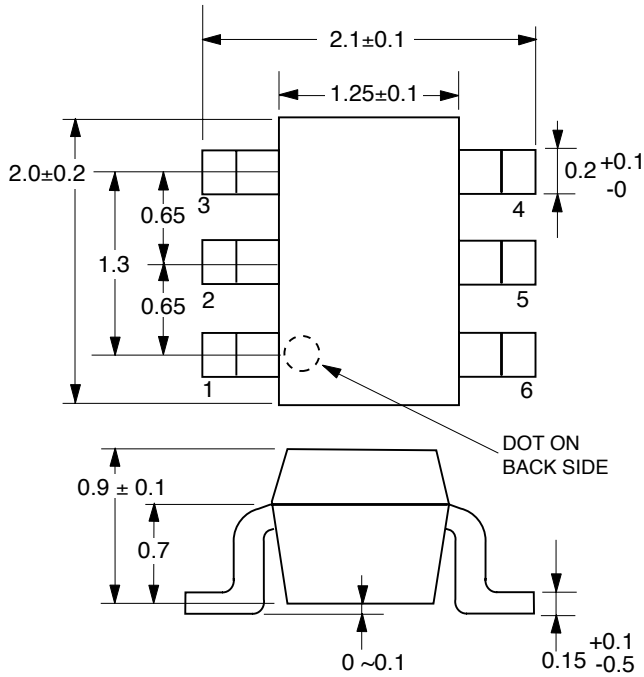


**EXAMPLE OF 2.4 GHz BAND RECEIVER**



**OUTLINE DIMENSIONS** (Units in mm)

**PACKAGE OUTLINE S06**  
(Top View)

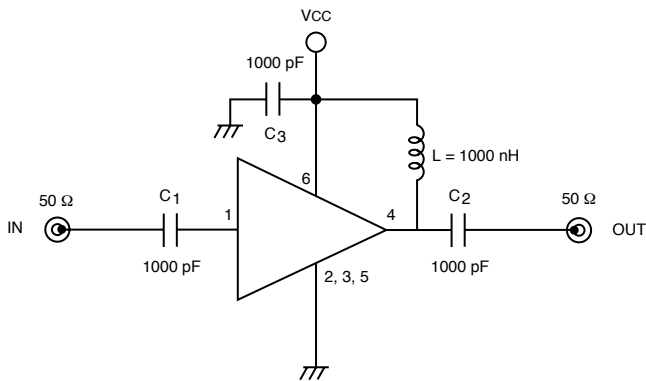


**ORDERING INFORMATION**

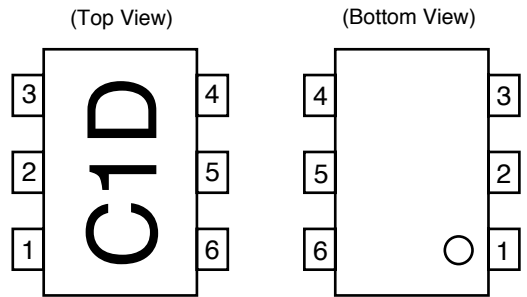
PART NUMBER	MARKING	QTY
UPC2708TB-E3-A	C1D	3K/Reel

Note:  
Embossed Tape, 8 mm wide. Pins 1, 2 and 3 face perforated side of tape.

**TEST CIRCUIT**



**PIN CONNECTIONS**



1. INPUT
2. GND
3. GND
4. OUTPUT
5. GND
6. VCC

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- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
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- Работу по проектам и поставку образцов.
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- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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